

/ Descriptions

WR0553I ММ Ё SQS æ Ñ ç s ll 1 Silicon PNP transistor in a TO-220F Plastic Package.

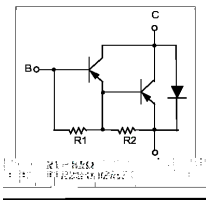
/ Features

лъ WLS455I Ы ´
Complement to TIP122F.

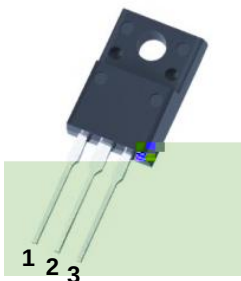
/ Applications

Љ ã Æ I ' ı ó Æ Ñ Õ º
Medium power linear switching applications.

/ Equivalent Circuit



/ Pinning



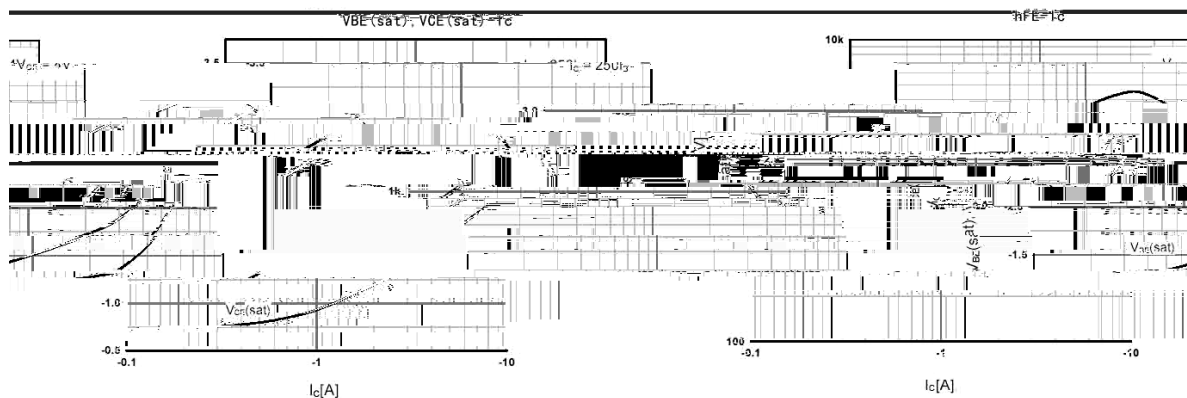
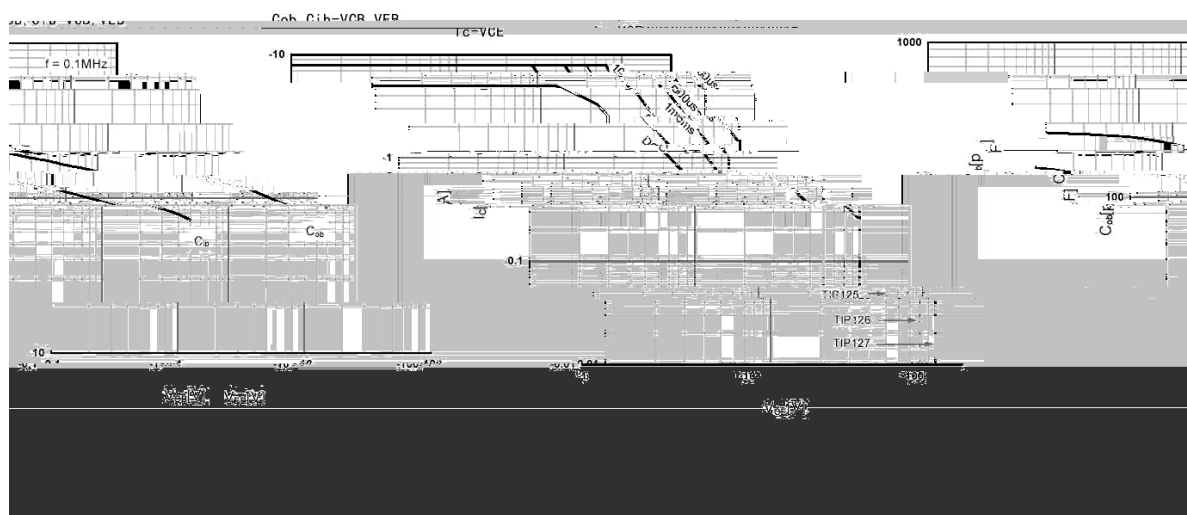
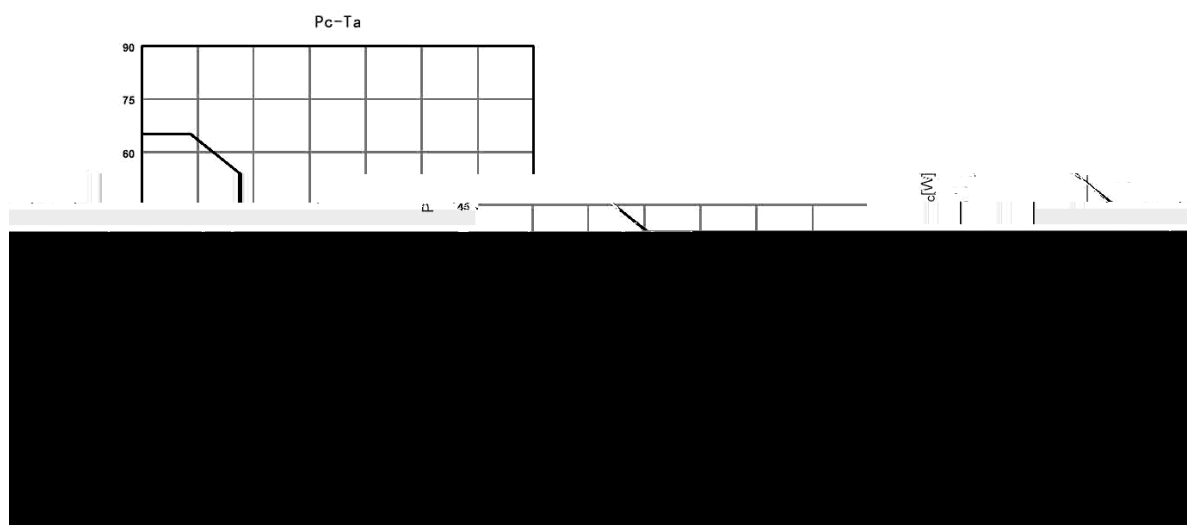
PIN1 χ Base PIN 2 χ Collector PIN 3 χ Emitter

/ h_{FE} Classifications & Marking

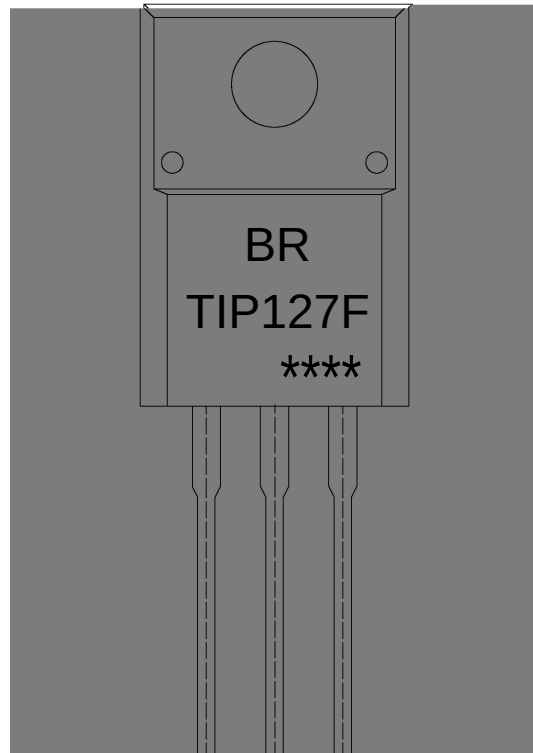
ó M ı ß ¨ See Marking Instructions.

Parameter	Symbol	Rating	Unit
Collector to Base Voltage	V_{CBO}	100	V

/ Electrical Characteristic Curve



/ Marking Instructions



ب"خ

EU χ

WLS45: I χ

-----X

Note:

BR:

TIP127F:

****.

ᠬᠠᠭ ᠰᠤ ᠠᠨᠤ ᠤᠯᠤᠰ

$$\mathbb{H} \quad f \quad \beta \quad \mathfrak{Z} \quad N$$

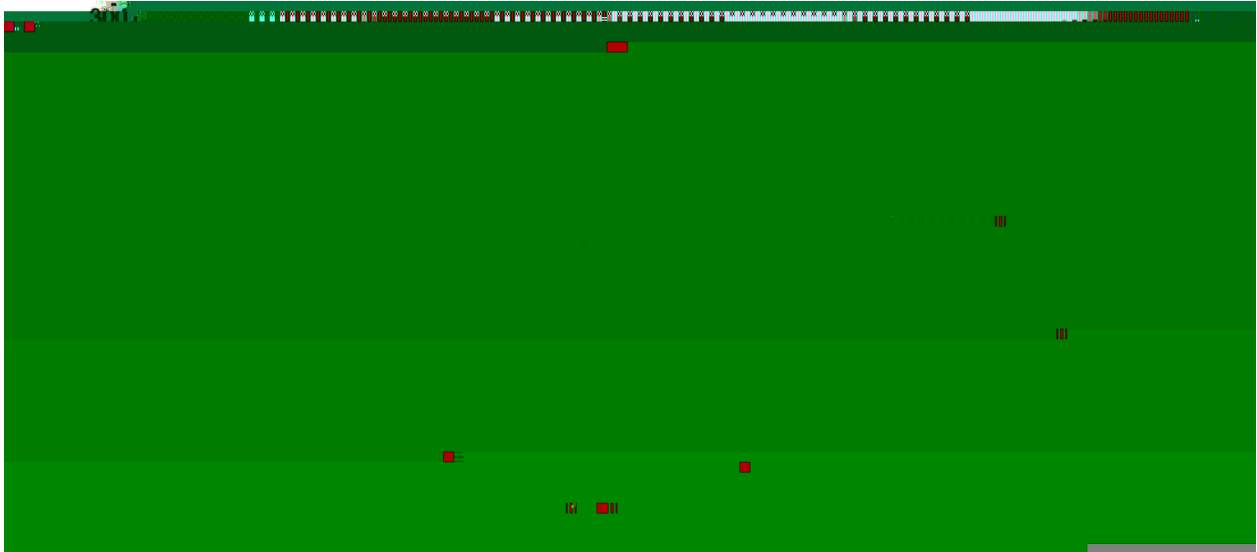
$\mathbb{H} \cdot f \check{\eta}^N \Gamma_D$ $\mathbb{I} \cdot \mathbb{E} \cdot f \check{\eta}^N \Psi \rho$

Company Code.

Product Type Code.

Lot No. Code, code change with Lot No.

() / Temperature Profile for Dip Soldering(Pb-Free)



б " X

1. 150 °C ~ 250 °C, Time: 60 ~ 90sec;
2. 255 °C ± 5 °C, Duration: 5 ± 0.5sec;
3. Cooling Speed: 2 ~ 10 °C /sec.

Note:

1. Preheating: 25~150 °C, Time: 60~90sec.
2. Peak Temp.: 255 °C ± 5 °C, Duration: 5 ± 0.5sec.
3. Cooling Speed: 2~10 °C /sec.

/ Resistance to Soldering Heat Test Conditions

150 °C ± 5 °C, Time: 10 ± 1 sec. Temp: 270±5 Time: 10±1 sec

/ Packaging SPEC.

“Q” γ t / BULK

Package Type	Units					Dimension (unit mm3)		
	Units/Bag /	Bags/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Bag	Inner Box	Outer Box
TO-220F	200	10	2,000	5	10,000	135×190	237×172×102	560×245×195

γ t / TUBE

Package Type	Units	Dimension (unit mm3)
Units/TuUnits/PC		